
INFORMATION DISCLOSURE CITATION			ATTY. DOCKET NO. SERIAL NO.				
			2344-738 10/052,890				
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EF	4,058,430	11/15/77	Suntola et al.	156	611		
EF	4,389,973	6/28/83	Suntola et al.	118	725		
FP	4,413,022	11/1/83	Suntola et al.	427	255.2		
EP	4,416,933	11/22/83	Antson et al.	428	216		
ER	4,533,410	8/6/85	Ogura et al.	148	175		
EF	4,533,820	8/6/85	Shimizu	219	411		
EF	4,689,247	8/25/87	Doty et al.	427	126.1		
EF	4,828,224	5/9/89	Crabb et al.	251	298		
EF	4,836,138	6/6/89	Robinson et al.	118	666		
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INITIALS						YES	NO
EF	0 442 490 A1	8/21/91	EP	C30B	25/02		
EF	0 442 490 B1	8/21/91	ЕР	C30B	25/02		
EF	0 511 264 B1	11/4/92	ЕР	B01J	37/02		
EF	WO 91/10510	7/25/91	PCT	BOIJ	37/02		
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EXAMINER'S INITIALS	PATENT NO.	DATE	NAME	CLASS	SUBCLASS	FILIN	IG DATE	
EF	4,846,102	7/11/89	Ozias	118	730			
rf	4,907,862	3/13/90	Suntola	350	345			
EF	4,913,929	4/3/90	Moslehi et al.	427	39			
BF	4,975,252	12/4/90	Nishizawa et al.	422	245			
EP	4,976,996	12/11/90	Monkowski et al.	427	255.5			
· EF	4,933,360	2/19/91	Nakamura	118				
EF	5,000,113	3/19/91	Wang et al.	118	723			
W.	5,015,503	5/14/91	Varrin Jr. et al.	427	255.2		· · · · · · · · · · · · · · · · · · ·	
EF	5,077,875	1/7/92	Hoke et al.	29	25.01			
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	8-236459	9/13/96	JP	HOIL	21/205			
	10-102256	4/21/98	JP	H01L	16/44		局	
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EF	5,078,851	1/7/92	Nishihata et al.	204	298.4		
CF	5,119,760	6/9/92	McMillan et al.	118	722		
F	5,156,820	10/20/92	Wong et al.	422	186.05		
Ef	5,194,401	3/16/93	Adams et al.	437	173		
Œ	5,204,314	4/20/93	Kirlin et al.	505	1		
ef	5,270,247	12/14/93	Sakuma et al.	437	133		
EF	5,281,274	1/25/94	Yoder	118	697		
UF.	5,294,778	3/15/94	Carman et al.	219	385		
Œ	5,320,680	6/14/94	Learn et al.	118	724		
EF	5,336,327	8/9/94	Lee	118	730		
EF	5,484,484	1/16/96	Yamaga et al.	118	719		
P	5,582,866	12/10/96	White	427	248.1		
E	5,693,139	12/2/97	Nishizawa et al.	117	89		
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EF	5,711,811	1/27/98	Suntola et al.	118	711		
Ef	5,749,974	5/12/98	Habuka et al.	118	725		
EF	5,788,447	8/4/98	Yonemitsu et al.	414	217		
EF	5,851,849	12/22/98	Comizzoli et al.	438	38		
EF	5,916,365	6/29/99	Sherman	117	92		
FF	5,935,338	8/10/99	Lei et al.	118	725		
EE	6,007,330	12/28/99	Gauthier	432	47		
El	6,015,590	1/18/00	Suntola et al.	427	255.23		
EF	6,042,652	3/28/00	Hyun et al.	118	719		
EF	6,050,216	4/18/00	Szapucki et al.	118	723		
EF	6,077,775	6/20/00	Stumborg et al.	438	643		
ÉP	6,090,442	7/18/00	Klaus et al.	427	255.15		
EF	6,139,700	10/31/00	Kang et al.	204	192.17		
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